

RoHS

COMPLIANT HALOGEN

FREE

Vishay Siliconix

N-Channel 30 V (D-S) MOSFET

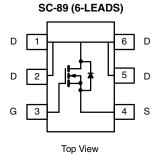
PRODUCT SUMMARY						
V _{DS} (V)	R_{DS(on)} (Ω)	I _D (A)	Q _g (Typ.)			
30	0.099 at V _{GS} = 4.5 V	1.2 ^a	3.5			
30	0.140 at V_{GS} = 2.5 V	1.0	0.0			

FEATURES

- Halogen-free According to IEC 61249-2-21
 Definition
- TrenchFET[®] Power MOSFET
- 100 % R_g and UIS Tested
- Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

Load Switch for Portable Devices



Marking Code

Ordering Information: Si1070X-T1-GE3 (Lead (Pb)-free and Halogen-free)

ABSOLUTE MAXIMUM RATINGS (T _A = 25 °C, unless otherwise noted)						
Parameter	Symbol	Limit	Unit			
Drain-Source Voltage	V _{DS}	30	v			
Gate-Source Voltage		V _{GS}	± 12	v		
	T _A = 25 °C	1-	1.2 ^{b, c}			
Continuous Drain Current $(T_J = 150 \ ^{\circ}C)^a$	T _A = 70 °C		1 ^{b, c}			
Pulsed Drain Current		I _{DM}	6	- A		
Avalanche Current	L = 0.1 mH	I _{AS}	9			
Repetitive Avalanche Energy	L = 0.1 IIIH	E _{AS}	4.01	mJ		
Continuous Source-Drain Diode Current	T _A = 25 °C	۱ _S	0.2 ^{b, c}	A		
	T _A = 25 °C	- P _D -	0.236 ^{b, c}	w		
Maximum Power Dissipation ^a	T _A = 70 °C] ' ^D [0.151 ^{b, c}	vv		
Operating Junction and Storage Temperature Ra	T _J , T _{stg}	- 55 to 150	°C			

THERMAL RESISTANCE RATINGS						
Parameter	Symbol	Typical	Maximum	Unit		
Manimum hunsting to Americanth d	t ≤ 5 s	B	440	530	°C/W	
Maximum Junction-to-Ambient ^{b, d}	Steady State	R _{thJA}	540	650		

Notes:

a. Based on T_C = 25 °C.

b. Surface mounted on 1" x 1" FR4 board.

c. t = 5 s.

d. Maximum under steady state conditions is 650 $^{\circ}\text{C/W}.$

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static		-				
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 V, I_D = 250 \mu A$	30			V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I _D = 250 μA		24.5		m\//ºC
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	$I_{\rm D} = 230 \ \mu \text{A}$		- 3.81		mV/°C
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \ \mu A$ (1.55	V
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 12 V$			± 100	nA
Zara Cata Valtaga Drain Current	I = • •	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$			1	nA
Zero Gate Voltage Drain Current	IDSS	$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 85 ^{\circ}\text{C}$			10	μΑ
On-State Drain Current ^a	I _{D(on)}	V_{DS} = \geq 5 V, V_{GS} = 4.5 V	6			Α
	Para	V _{GS} = 4.5 V, I _D = 1.2 A		0.082	0.099	
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = 2.5 V, I _D = 1.0 A	0.116 0.140		Ω	
Forward Transconductance	9 _{fs}	V _{DS} = 15 V, I _D = 1.2 A		5		S
Dynamic ^b						
Input Capacitance	C _{iss}			385		pF
Output Capacitance	C _{oss}	$V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}, \text{ f} = 1 \text{ MHz}$		55		
Reverse Transfer Capacitance	C _{rss}			30		
Tatal Cata Charge	0	$V_{DS} = 15 \text{ V}, \text{ V}_{GS} = 5 \text{ V}, \text{ I}_{D} = 1.2 \text{ A}$		3.8	8.3	nC
Total Gate Charge	Q _g			3.5	4.1	
Gate-Source Charge	Q _{gs}	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 4.6 \text{ A}$		1.1		
Gate-Drain Charge	Q _{gd}			0.98		
Gate Resistance	R _g	f = 1 MHz		4.7	6.2	Ω
Turn-On Delay Time	t _{d(on)}			10	15	
Rise Time	t _r	V_{DD} = 15 V, R_L = 15 Ω		22	33	ns
Turn-Off DelayTime	t _{d(off)}	$\text{I}_\text{D}\cong$ 1.0 A, V_GEN = 4.5 V, R_g = 1 Ω		14	21	
Fall Time	t _f			6	9	
Drain-Source Body Diode Characterist	ics					
Pulse Diode Forward Current ^a	I _{SM}				6	Α
Body Diode Voltage	V _{SD}	I _S = 1.2 A		0.8	1.2	V
Body Diode Reverse Recovery Time	t _{rr}			19.4	29.5	nC
Body Diode Reverse Recovery Charge	Q _{rr}			18.43	27.5	
Reverse Recovery Fall Time	t _a	I _F = 3.8 A, dI/dt = 100 A/μs		16.4		ns
Reverse Recovery Rise Time	t _b			3		1

Notes:

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

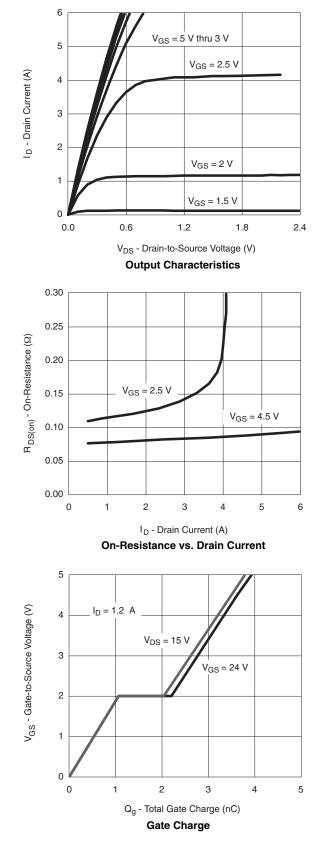
b. Guaranteed by design, not subject to production testing.

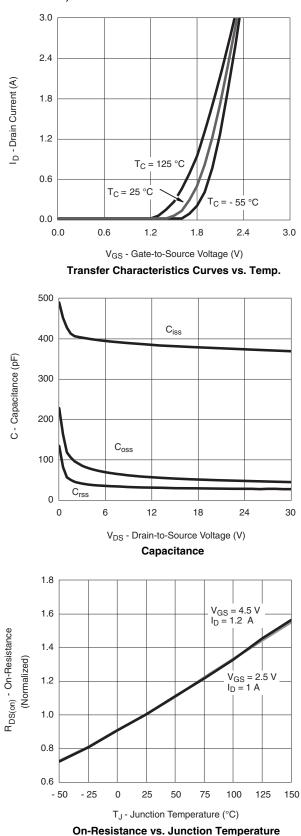
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



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TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)





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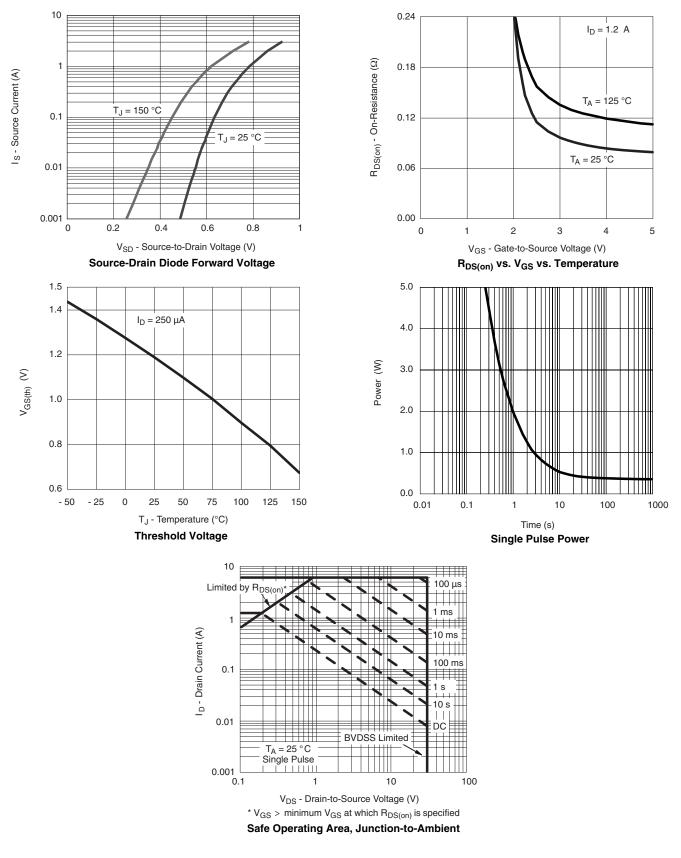
Downloaded from Elcodis.com electronic components distributor

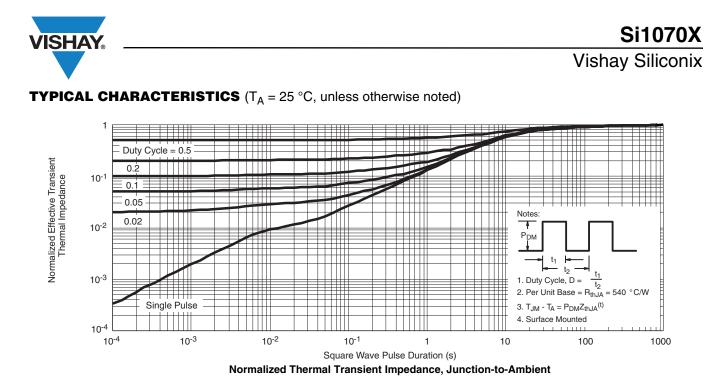
Si1070X

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TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)

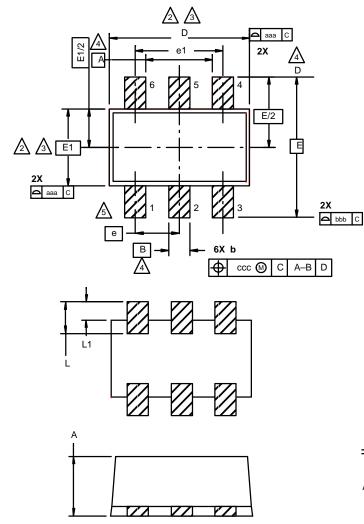




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SC89: 6- LEADS (SOT-563F)

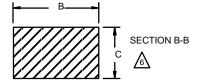


NOTES:

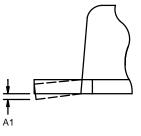
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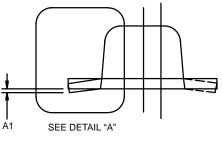
- 1. Dimensions in millimeters.
- Dimension D does not include mold flash, protrusions or gate burrs. Mold flush, protrusions or gate burrs shall not exceed 0.15 mm per dimension E1 does not include interlead flash or protrusion, interlead flash or protrusion shall not exceed 0.15 mm per side.
- ▲ Dimensions D and E1 are determined at the outmost extremes of the plastic body exclusive of mold flash, the bar burrs, gate burrs and interlead flash, but including any mismatch between the top and the bottom of the plastic body.
- A Datums A, B and D to be determined 0.10 mm from the lead tip.
 - Terminal numbers are shown for reference only.
- These dimensions apply to the flat section of the lead between 0.08 mm and 0.15 mm from the lead tip.

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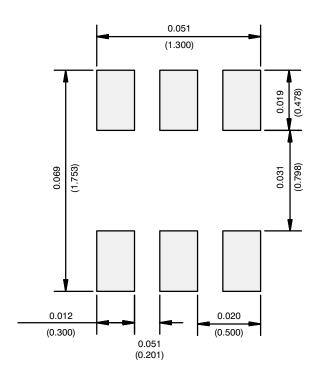
	MILLIMETERS				Tolerances Of Form And	
Dim	Min	Max	Note	Symbol	Position	
Α	0.56	0.60		aaa	0.10	
A1	0.00	0.10		bbb	0.10	
b	0.15	0.30		ссс	0.10	
С	0.10	0.18				
D	1.50	1.70	2, 3			
E	1.55	1.70				
E1	1.20 BSC		2, 3			
е	0.50 BSC					
e1	1.00 BSC					
L	0.35 BSC					
L1	0.20 BSC					
ECN: E-00499—Rev. B, 02-Jul-01 DWG: 5880						



Application Note 826

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RECOMMENDED MINIMUM PADS FOR SC-89: 6-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)

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